# **MSA-0236**

# Cascadable Silicon Bipolar MMIC Amplifier



# **Data Sheet**

### **Description**

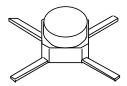
The MSA-0236 is a high performance silicon bipolar Monolithic Microwave Integrated Circuit (MMIC) housed in a cost effective, microstrip package. This MMIC is designed for use as a general purpose  $50\Omega$  gain block. Typical applications include narrow and broad band IF and RF amplifiers in industrial and military applications.

The MSA-series is fabricated using Avago's 10 GHz  $f_T$ , 25 GHz  $f_{MAX}$ , silicon bipolar MMIC process which uses nitride self-alignment, ion implantation, and gold metallization to achieve excellent performance, uniformity and reliability. The use of an external bias resistor for temperature and current stability also allows bias flexibility.

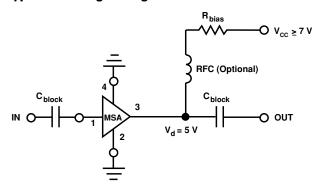
### **Features**

- Cascadable 50  $\Omega$  Gain Block
- 3 dB Bandwidth: DC to 2.7 GHz
- 12.0 dB Typical Gain at 1.0 GHz
- Unconditionally Stable (k>1)
- · Cost Effective Ceramic Microstrip Package

## 36 micro-X Package



### **Typical Biasing Configuration**



## **MSA-0236 Absolute Maximum Ratings**

Parameter	Absolute Maximum <sup>[1]</sup>				
Device Current	60 mA				
Power Dissipation <sup>[2,3]</sup>	325 mW				
RF Input Power	+13 dBm				
Junction Temperature	150°C				
Storage Temperature <sup>[4]</sup>	−65 to 150°C				

Thermal Resistance <sup>[2,5]</sup> :
$\theta_{\rm jc} = 145^{\circ}{ m C/W}$

#### **Notes:**

- 1. Permanent damage may occur if any of these limits are exceeded.
- 2.  $T_{CASE} = 25$ °C.
- 3. Derate at 6.9 mW/°C for  $T_C > 153$ °C.
- 4. Storage above  $+150^{\circ}$ C may tarnish the leads of this package making it difficult to solder into a circuit.
- 5. The small spot size of this technique results in a higher, though more accurate determination of  $\theta_{\rm jc}$  than do alternate methods.

## Electrical Specifications $^{[1]}$ , $T_{A}=25^{\circ}C$

Symbol	Parameters and Test Conditions:	Units	Min.	Тур.	Max.	
GP	Power Gain ( S <sub>21</sub>   <sup>2</sup> )	f = 0.1 GHz	dB	11.5	12.5	13.5
$\Delta G_{ m P}$	Gain Flatness	f = 0.1 to 1.6 GHz	dB		±0.6	±1.0
$f_{3 \text{ dB}}$	3 dB Bandwidth		GHz		2.7	
VSWR	Input VSWR	f = 0.1  to  3.0  GHz			1.2:1	
VOVIL	Output VSWR	f = 0.1  to  3.0  GHz			1.4:1	
NF	$50~\Omega$ Noise Figure	f = 1.0  GHz	dB		6.5	
P <sub>1 dB</sub>	Output Power at 1 dB Gain Compression	f = 1.0  GHz	dBm		4.5	
$IP_3$	Third Order Intercept Point	f = 1.0  GHz	dBm		17.0	
$t_{\mathrm{D}}$	Group Delay	f = 1.0  GHz	psec		125	
$V_{\rm d}$	Device Voltage		V	4.5	5.0	5.5
dV/dT	Device Voltage Temperature Coefficient		mV/°C		-8.0	

### Note:

1. The recommended operating current range for this device is 18 to 40 mA. Typical performance as a function of current is on the following page.

### **Ordering Information**

Part Numbers	No. of Devices	Comments		
MSA-0236-BLKG	100	Bulk		
MSA-0236-TR1G	1000	7" Reel		

$\sum_{i=1}^{n} \sum_{j=1}^{n} \sum_{i=1}^{n} \sum_{j=1}^{n} \sum_{j=1}^{n} \sum_{j=1}^{n} \sum_{i=1}^{n} \sum_{j=1}^{n} \sum_{i=1}^{n} \sum_{j=1}^{n} \sum_{j$	MSA-0236 Typical Scattering	Parameters (Z,	$_{n}$ = 50 $\Omega$ , T,	、 = 25°C, I	, = 25 mA)
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Freq.	Freq. S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>			S <sub>22</sub>		
GHz	Mag	Ang	dB	Mag	Ang	dB	Mag	Ang	Mag	Ang
0.1	.08	170	12.6	4.25	176	-18.6	.118	2	.16	-6
0.2	.08	163	12.5	4.23	171	-18.5	.119	2	.15	-10
0.4	.08	147	12.5	4.19	161	-18.4	.120	4	.15	-21
0.6	.08	130	12.4	4.14	152	-18.3	.121	4	.15	-30
0.8	.07	112	12.2	4.09	143	-18.1	.125	7	.15	-39
1.0	.07	91	12.1	4.02	134	-18.0	.126	10	.15	-46
1.5	.06	47	11.6	3.80	112	-17.3	.137	11	.13	-66
2.0	.03	-1	11.0	3.53	91	-16.3	.153	10	.11	-89
2.5	.03	-115	10.2	3.24	75	-15.4	.169	12	.09	-111
3.0	.09	-157	9.3	2.92	57	-15.1	.176	8	.08	-127
3.5	.16	-175	8.3	2.60	39	-14.4	.190	3	.09	-129
4.0	.20	173	7.2	2.29	23	-14.1	.198	-2	.11	-118
5.0	.27	136	5.2	1.81	-6	-13.5	.211	-11	.15	-117
6.0	.41	94	3.2	1.44	-33	-13.5	.212	-24	.11	-148

# Typical Performance, $T_A = 25^{\circ}C$

(unless otherwise noted)

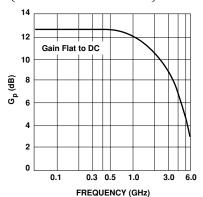


Figure 1. Typical Power Gain vs. Frequency,  $T_A$  = 25°C,  $I_d$  = 25 mA.

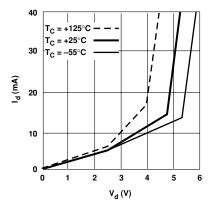


Figure 2. Device Current vs. Voltage.

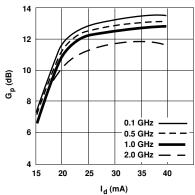
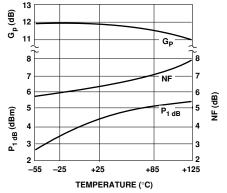


Figure 3. Power Gain vs. Current.



 $\label{eq:figure 4. Output Power at 1 dB Gain Compression, NF and Power Gain vs. \\ Mounting Surface Temperature, \\ f=1.0~GHz, I_d=25~mA.$ 

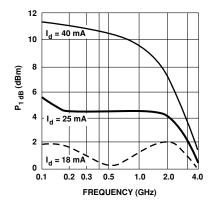


Figure 5. Output Power at 1 dB Gain Compression vs. Frequency.

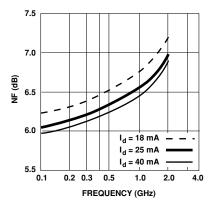
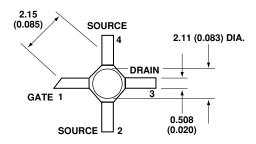
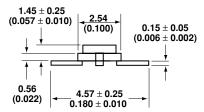


Figure 6. Noise Figure vs. Frequency.

## 36 micro-X Package Dimensions





#### Notes:

- 1. Dimensions are in millimeters (inches)
- 2. Tolerances: in .xxx =  $\pm$  0.005 mm .xx =  $\pm$  0.13

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